

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5105830

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAQUAN YU	07/30/2018
RECEIVING PARTY DATA	
Name:	HUATIAN TECHNOLOGY (KUNSHAN) ELECTRONICS CO., LTD.
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City:	KUNSHAN, JIANGSU
State/Country:	CHINA
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16109955
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DATE SIGNED:	08/23/2018
Total Attachments: 1	
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ASSIGNMENT OF PATENT APPLICATION

Whereas I, an undersigned inventor, have invented certain new and useful improvements as set forth in the patent application entitled:

EMBEDDED SILICON SUBSTRATE FAN-OUT TYPE 3D PACKAGING STRUCTURE

(Docket No. 17-11093US). (check one)

- ☒ for which I have executed a U.S. patent application on even date herewith. (Accompanying)
☐ which bears U.S. application No. . (Not accompanying)
☐ which is a U.S. provisional application. (Accompanying)

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, an undersigned inventor, hereby:

- 1) Sell, assign and transfer to HUATIAN TECHNOLOGY (KUNSHAN) ELECTRONICS CO., LTD., a corporation in the People's Republic of China having a place of residence at 112 Longteng Road, Economic & Technical Development Zone, Kunshan, Jiangsu, 215300, China ("ASSIGNEE"), the entire right, title and interest in any and all improvements and inventions disclosed in. applications based upon, and patents (including foreign patents and the right to claim priority) granted upon, the above-referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
- 6) Authorize and request my representative to insert above the application No. in order to assist with recordal of this assignment.

Signed on the date indicated beside my signature.

Inventor Signature: _____

Daquan YU

Daquan YU

Date: 07/30/2018

17-11093US